/c			· =		_	Docket Number (Optional)	00	Application Number	
O INFORMATION DISCLOSURE CITATION						03226.06400 09/819,773 Applicant(s)			
We several sheets if necessary)						Claude R. GAUTHIER, et al. Filing Date Group Art Unit			
וטנ _ ו	78	Ma				03/28/200	01		2836
U.S. PATENT DOCUMENTS									
EXAMINER INITIAL	REF		DOCUMENT NUMBER	DATE		NAME	CLASS	SUBCLASS	FILING DATE IF APPROPRIATE
	-		_						
			_				_		
-									
				į					
					 				
					-				
		-			<u> </u>				
	ļ	ļ	·· ·		-		_		
				_ \					
					FOREIC	N PATENT DOCUMEN	rs		
	REF		DOCUMENT NUMBER	DATE		COUNTRY	CLASS	SUBCLASS	Translation . YES NO
	A1	wo	01/17111 A1	03/08/2001	WIPO		G06F	17/50	
				1				HAC	고
								CHMCLOG	IIG -
	-				<u> </u>				
	-							CENTER	2203
	<u> </u>			<u> </u>					
			I		OTHER	DOCUMENTS (Include	ling Author, Title	e, Date, Pertinent	ages, Etc.)
	PCT International Search Report dated 3/28/2002, 3 pgs.								
		А3	Benjamin Beker, et al.; "Tradeoffs in Modeling the Response of Power Delivery Systems of High-Performance Microprocessors"; IEEE 9th Topical Meeting on Electrical Performance of Electronic Packaging, Scottsdale, AZ, October 23-25, 2000; pgs. 77-80						
EXAMINER Duent				DATE CONSIDERED 6/28/04					
EXAMINER: Initial if citation considered, whether or not citation is in conformance with MPEP Section 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.									

Form PTO-A820 (also form PTO-1449)

		03226.06400s	09/819,773			
	ATION DISCLOSURE CITATION (Use several sheets if necessary)	Applicant(s) Claude R. GAUTHIER, et al.				
. /0,,,	Ose several sneets if necessary	Filing Date	Group Art Unit			
	17682 14	03/28/2001	2836			
*EXAMINER JUL 2	OTHER DOCUMENTS (Including Author, Tit	tle, Date, Pertinent Pages, Etc.)				
ROLL .	1 SE		-			
B1	Dipennis J. Herrell, et al.; "Modeling of Power Distr IEEE Transactions on Advanced Packaging; Vol. 2	ibution Systems for High-Performa 22, No. 3, August 1999, pp. 240-248	nce Microprocessors";			
B2	Wiren D. Becker, et al.; "Modeling, Simulation, an Computer Systems"; IEEE Transactions on Comp May 1998; pp. 157-163	nd Measurement of Mid-Frequency (onents, Packaging, and Manufactur	Simultaneous Switching Noise in ing Technology - Part B; Vol. 21, No. 2,			
В3	Mondira Deb Pant, et al.; "On-Chip Decoupling C Prediction"; 13th Annual IEEE International ASI	apacitor Optimization Using Archit C/SOC Conference; September 13-1	ectural Level Current Signature 6, 2000; pp. 288-292			
		· · · · · · · · · · · · · · · · · · ·				
			RECEIVED AUG 1 200			
			IVED 1 2003 CENTER 2800			
			2800			
examiner		DATE CONSIDERED 6/2-6/04				
*EXAMINER: Initial not considered. Include	if citation considered, whether or not citation is in conform de copy of this form with next communication to applicant.	nance with MPEP Section 609; Draw lin	e through citation if not in conformance and			